

SMT current sense transformers

EE 4.2 Core

Series/Type: B82801A1

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SMT current sense transformers

B82801A1

EE 4.2 Core

Features

- Ferrite core
- Very low DC resistance
- Different turns ratio
- Very small package
- RoHS compatible
- Moisture Sensitivity Level (MSL) 1
- Qualified acc. IEC 62211
- AEC-Q200 Grade 1

Applications

- Switching power supplies
- Feedback control
- Overload sensing
- Load drop/shut down detection

Terminals

■ SMD

Marking

- No marking on component (Batch-/date code tracking in responsible to user)
- Label on packing:
 Date code, ordering code, production place identification code

Delivery mode

- 16 mm blister tape, 178 mm Ø reel
- Cardboard box packaging
- Packing units: 600 pcs. / reel

3000 pcs. / cardboard box

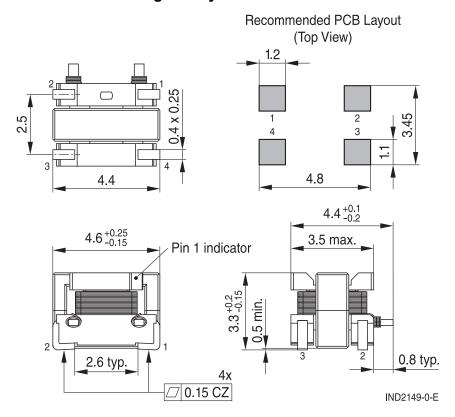
Remark

Variation in core coating color is possible



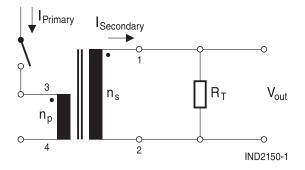


Dimensional drawing and layout recommendation



Dimensions in mm

Application circuit and pinning

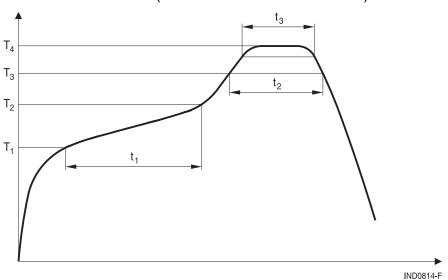


Technical data and measuring conditions

Typical operational frequency	50 1000 kHz			
High voltage test AC Np / Ns	750 V RMS, 50 Hz, 1 s (routine test)			
High voltage test AC Np / Ns	750 V RMS, 50 Hz, 60 s (type test)			
Inductance L _{min} (1-2)	100 kHz, 100 mV, @ +25 °C			
DC resistance R _{max}	Measured at +25 °C			
Sensed current	The max. input current of 7 A causes approx. +25 °C temperature rise, see <i>Current vs temperature rise</i> curve.			
Solderability	\geq 99.9 Sn, lead-free. Or Sn96.5Ag3.0Cu0.5: +(245 \pm 5) °C, (3 \pm 0.3) s Wetting of soldering area \geq 95% (to IEC 60068-2-58)			
Resistance to soldering heat	ccording to JEDEC J-STD 020 E, Tp = +260 °C Refer the graph below)			
Storage conditions (packaged)	–20 °C +40 °C, ≤ 75% RH			
Operating temperature range	−40 °C +125 °C			
Weight	Approx. 0.15 g			

Recommended reflow soldering curve

Pb-free solder material (based on JEDEC J-STD 020E)



T ₁ °C	T ₂ °C	T ₃ °C	T ₄ °C	t ₁	t ₂	t ₃
150	200	217	250	60 – 120	60 – 150	< 30 @ T ₄ –5 °C

Time from +24 °C to T_4 : max. 480 s

$$B_{max} = \frac{V_{out, max} \cdot \delta_{max}}{N_{s} \cdot A_{e} \cdot f_{osc}}$$

With:

 B_{max} Maximum magnetic flux density in the ferrite core of the current sense

transformer

 $V_{out,max}$ Maximum output voltage of the measurement signal

Maximum duty cycle δ_{max}

Number of turns of the secondary winding of the current sense transformer N_s

Effective magnetic area of the ferrite core A_{e}

Operating frequency of the switching operator IC f_{osc}

Typical value for A_e : $10.7 \times 10^{-6} \text{ m}^2$ < 220 m T Typical B_{max}:

$$R_T = \frac{V_{out, max} \cdot N_s}{I_{IN, max}}$$

With:

 R_T Resistance of burden resistor

Maximum output voltage of the measurement signal $V_{out.max}$ N_s Number of turns of the secondary side of the CST

Maximum input current (peak current) I_{IN.max}

Characteristics and ordering codes

L _{min} (1-2)	Turns ratio	DC resistance R _{max} (mΩ)		Voltage-time product at n _s ¹⁾	Recomm. R _T ²⁾	Ordering code
μΗ	n _p : n _s	primary	secondary	V•µs	Ω	
33	1:20	2.5	700	5.8	2.8	B82801A1333A020
74	1:30	2.5	1100	8.6	4.2	B82801A1743A030
132	1:40	2.5	1500	11.5	5.7	B82801A1134A040
205	1:50	2.5	2400	14.4	7.1	B82801A1214A050
295	1:60	2.5	3600	17.3	8.6	B82801A1304A060
400	1:70	2.5	4600	20.0	10.0	B82801A1404A070
820	1:100	2.5	9000	28.8	14.3	B82801A1824A100
1280	1:125	2.5	15000	36.0	17.9	B82801A1135A125
1840	1:150	2.5	22700	43.2	21.4	B82801A1185A150

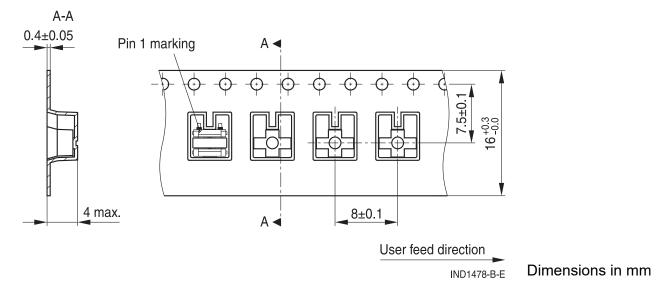
¹⁾ The maximum volt-sec rating limits the peak flux density to 220 mT when used in a unipolar drive application. For bipolar drive applications, a maximum volt-sec of two times is acceptable.

²⁾ The Burden Resistor value is calculated by taking Vout as 1 V reference and with maximum input current (7 A) flowing through the primary winding of the current sense transformer.

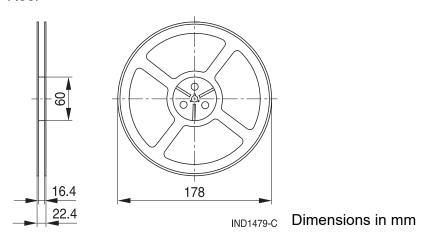


Taping and packing

Blister tape

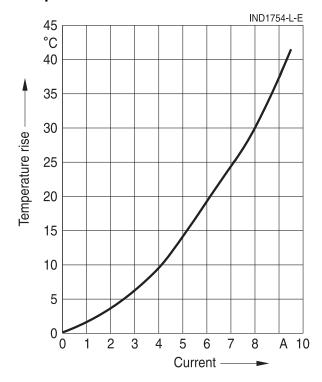


Reel





Temperature rise of the transformer





Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
 - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
 - Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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